

RFM News Release

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RFM Announces Upgrade of Wafer Fab Support for Future Demand of New and Existing Products

Dallas, Texas (September 17, 1998) RF Monolithics, Inc. (RFM) (Nasdaq: RFMI) has added a 4-inch wafer fabrication capability to its existing 3-inch line, which increases capacity by 85% for each wafer produced. The Company anticipates this will result in significant labor cost savings. This is part of RFM's on-going strategy to remain competitive and reduce costs, while maintaining stable margins. The Company plans further Wafer Fab expansion to include two "T" line steppers, which will allow the Company to respond to demand for higher frequency devices.

"These upgrades ensure we continue to increase our fabrication capacity and reduce our costs within existing space, which minimizes the capital investment required," said Sam L. Densmore, President and Chief Executive Officer, "We believe this further positions us to respond to the increasing demand for our products and ensure capacity to handle future requirements".

RFM, headquartered in Dallas, Texas is a leading developer, manufacturer and supplier of a broad range of radio frequency components and modules based on surface acoustic wave technology for the automotive, computer, consumer, industrial and telecommunications markets worldwide.

Except for the historical information contained herein, this news release contains forward-looking statements that involve risks and uncertainties, including timely development, acceptance and pricing of new products, product mix, the impact of competitive products and pricing, general economic conditions as they affect the Company's customers, as well as the other risks detailed from time to time in the Company's SEC reports, including the report on Form 10-K for the year dated August 31, 1997.

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